

旭創科技股份有限公司

RSiN Technology Co., Ltd.

SPECIFICATION FOR APPROVAL

製品規格書 SPEC NO: **SAAMP190101**

CUSTOMER:

客戶名稱:

CUSTOMER PART NO:

客戶料號:

PART NO:

AMP Series

旭創料號:

QUANTITY:

數量:

10

PCS

DATE:

2019/2/13

日期:

REV NO:

1.0

版本:

CUSTOMER APPROVE

RSIN SIGNATURE CUSTOMER SIGNATURE



Approved Rejected

R&D DEPARTMENT

PREPARED BY **CHECKED BY APPROVED BY**

制定 複核 核准

> Davy Amanda Vincent

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旭創科技股份有限公司

RSiN Technology Co., Ltd.

Revision History

變更履歷

PART NO:

AMP Series

旭創料號:

| 版本 | 修改日期 | 變更內容及理由 | 制定 | 複核 | 核准 |
|---------|--------------|-------------------------------|----------|---------|----------|
| REV. No | REVISED DATE | REASON AND DETAIL OF REVISION | PREPARED | CHECKED | APPROVED |
| 1.0 | 2019/2/13 | 第一版發行 | Davy | Amanda | Vincent |
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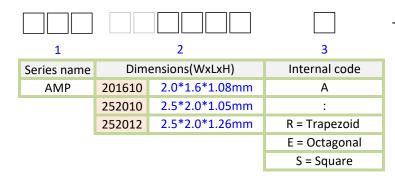
⊕ Feature

- High current saturation.
- Magnetically Shielded Structure.
- •Low profile construction and miniature size.

⊕ Applications

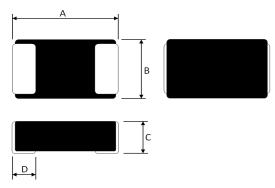
- •DC to DC converters.
- Power line filtering.
- •DVC/DSC/PDA, LCD display.

Product Identification:

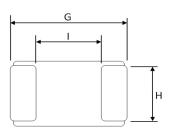


| - | | | | |
|---|------|---------|-------|------|
| | | 4 | 5 | 5 |
| | Indu | uctance | Toler | ance |
| | 1R0 | 1 μΗ | J | 5% |
| | 100 | 10 μΗ | K | 10% |
| | 101 | 100 μΗ | М | 20% |
| | 102 | 1000 μΗ | N | 30% |

⊕ Shapes And Dimensions

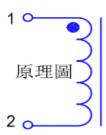


⊕Recommended PCB Pattern



| Part No. | Dimensions(mm) | | | | | | | | | |
|-------------|----------------|-------|------|-------|--|------|------|------|--|--|
| Fait NO. | Α | В | С | D | | G | Н | I | | |
| AMP201610 | 2.0 | 1.6 | 1.00 | 0.50 | | 2.00 | 1.60 | 0.90 | | |
| AMPZUTOTU | ±0.20 | ±0.20 | Max. | ±0.30 | | Ref | Ref | Ref | | |
| AMP252010 | 2.5 | 2.0 | 1.00 | 0.60 | | 2.80 | 2.00 | 1.20 | | |
| AIVIPZJZUTU | ±0.20 | ±0.20 | Max. | ±0.30 | | Ref | Ref | Ref | | |
| AMP252012 | 2.5 | 2.0 | 1.20 | 0.60 | | 2.80 | 2.00 | 1.20 | | |
| | ±0.20 | ±0.20 | Max. | ±0.30 | | Ref | Ref | Ref | | |

⊕ Equivalent Circuit Schematic :



⊕ Material List:

| No. | Supplier | Location | Material |
|-----|-------------|----------|-----------------------|
| 1 | TopCore | Core | Metal alloy powder |
| 2 | Elektrisola | Wire | Grade1 P180 |
| 3 | GAOXIN | Solder | Sn99.3 Cu0.7 |
| 4 | RSiN | Ероху | Magnetic powder resin |
| 5 | - | - | - |

^{1.}Operating temperature -40°C ~ +125°C

^{2.}Storage conditions -50 $^{\circ}$ C ~ +125 $^{\circ}$ C



⊕ Electrical Characteristics :

| Part No. | Inductance | | DCR (mΩ) | | Isat (A) | | Irms (A) | | Test Frequuency | |
|-----------------|------------|-------|----------|------|----------|------|----------|------|-----------------|--|
| rait NO. | (μH) | | Max. | Тур. | Max. | Тур. | Max. | Тур. | restriedudency | |
| AMP201610S-R24M | 0.24 | ± 20% | 21 | 17 | 5.05 | 5.60 | 4.50 | 5.00 | 1MHz / 1V | |
| AMP201610S-R33M | 0.33 | ± 20% | 29 | 24 | 4.50 | 5.00 | 3.69 | 4.10 | 1MHz / 1V | |
| AMP201610S-R47M | 0.47 | ± 20% | 40 | 33 | 4.00 | 4.40 | 3.15 | 3.50 | 1MHz / 1V | |
| AMP201610S-R68M | 0.68 | ± 20% | 49 | 41 | 3.33 | 3.70 | 3.06 | 3.40 | 1MHz / 1V | |
| AMP201610S-1R0M | 1 | ± 20% | 69 | 60 | 2.61 | 2.90 | 2.26 | 2.60 | 1MHz / 1V | |
| AMP201610S-1R5M | 1.5 | ± 20% | 129 | 114 | 2.25 | 2.50 | 1.81 | 2.00 | 1MHz / 1V | |
| AMP201610S-2R2M | 2.2 | ± 20% | 150 | 135 | 1.71 | 1.90 | 1.50 | 1.70 | 1MHz / 1V | |

⊕ Electrical Characteristics:

| Part No. | Inductance | | DCR (mΩ) | | Isat (A) | | Irms (A) | | Test Frequuency | |
|-----------------|------------|-------|----------|------|----------|------|----------|------|------------------|--|
| raitino. | (μH) | | Max. | Тур. | Max. | Тур. | Мах. | Тур. | i restriedudency | |
| AMP252010S-R22M | 0.22 | ± 20% | 12.5 | 9 | 7.2 | 7.9 | 5.3 | 5.9 | 1MHz / 1V | |
| AMP252010S-R33M | 0.33 | ± 20% | 26 | 21 | 6 | 6.6 | 4 | 4.4 | 1MHz / 1V | |
| AMP252010S-R47M | 0.47 | ± 20% | 32 | 27 | 4.5 | 5 | 3.51 | 3.9 | 1MHz / 1V | |
| AMP252010S-R68M | 0.68 | ± 20% | 44 | 37 | 3.87 | 4.3 | 3.06 | 3.4 | 1MHz / 1V | |
| AMP252010S-1R0M | 1 | ± 20% | 54 | 45 | 3.15 | 3.5 | 2.7 | 3 | 1MHz / 1V | |
| AMP252010S-1R5M | 1.5 | ± 20% | 91 | 76 | 2.34 | 2.6 | 2.25 | 2.5 | 1MHz / 1V | |
| AMP252010S-2R2M | 2.2 | ± 20% | 119 | 99 | 2.16 | 2.4 | 2.07 | 2.3 | 1MHz / 1V | |
| AMP252010S-4R7M | 4.7 | ± 20% | 262 | 220 | 1.62 | 1.8 | 1.22 | 1.36 | 1MHz / 1V | |

⊕ Electrical Characteristics:

| Part No. | Indu | ctance | DCR | (mΩ) | Isat | (A) | Irms | s (A) | Test Frequuency |
|-----------------|------|--------|------|------|------|------|------|-------|-----------------|
| rait NO. | (μH) | | Max. | Тур. | Max. | Тур. | Max. | Тур. | restriequaeticy |
| AMP252012S-R47M | 0.47 | ± 20% | 25 | 21 | 4.95 | 5.3 | 4.18 | 4.6 | 1MHz / 1V |
| AMP252012S-R68M | 0.68 | ± 20% | 35 | 29 | 4.63 | 5 | 3.36 | 3.7 | 1MHz / 1V |
| AMP252012S-1R0M | 1 | ± 20% | 49 | 41 | 4.04 | 4.4 | 3.18 | 3.5 | 1MHz / 1V |
| AMP252012S-1R5M | 1.5 | ± 20% | 77 | 64 | 2.91 | 3.2 | 2.27 | 2.5 | 1MHz / 1V |
| AMP252012S-2R2M | 2.2 | ± 20% | 98 | 85 | 2.73 | 3 | 2.06 | 2.27 | 1MHz / 1V |
| AMP252012S-4R7M | 4.7 | ± 20% | 235 | 196 | 1.58 | 1.9 | 1.4 | 1.61 | 1MHz / 1V |

Note: Specifications which provide more details for the proper and safe use of the described product are available upon request. all specifications are subject to change without notice.

Isat: DC Saturation Current that will cause initial inductance to drop approximately 30% max.

Irms : DC Current that will cause an approximate ΔT of 40 $^{\circ} C$

Test Instrument:

L: LCR meter 4285A or equivalent.

DCR: HIOKI micro-ohm meter RM3542 or equivalent.



⊕ General Characteristics

| General Characteristics | | |
|---------------------------------|--|--|
| 項目 Item | Conditions | Specification |
| 温度特性 Temperature drift | | Inductance temperature coefficient 2000 ppm/°C or less |
| 保存温度范围 Storage Temperature | 在包装的状态下。 With taping. | - 50°C ~ + 125°C |
| 使用温度范围 Operating Temperature | 包括制品的发热温度。 Including self temperature rise. | - 40°C ~ + 125°C |
| 弯曲测试 Bending test | Change from an initial value L : within±10% | |
| 固着强度 Adhesion strength | 按箭头方向用R0.5 的加压棒在试件中施加一定的静力并保持60±5秒. A static load using a R0.5 pressing tool shall be applied the arrow and to the body of the specimen in the direction of the arrow and shall be hold for 60±5s. Measure after removing pressure. Specimen 1st 5N 2nd 5N | Change from an initial value L : within±10% |



| 耐振性 Vibration | 振动频率10~55~10Hz, 振幅1.5mm, 分X,Y,Z 方向各振动1 小时(共3 小时)。 The specimen shall be subjected to a vibration of 1.5mm amplitude, sweep frequency 10~55Hz (10Hz to 55Hz to 10Hz in a period of one minute) for 1 h in each of 3(X,Y,Z) axes. | Change from an initial value L : within±10% |
|-----------------------------|---|--|
| 耐冲击性 Mechanical shock | 利用橡胶块式落下冲击试验机,分别在3 个互相垂直的方向以981m/S2 的冲击加速度落下。 Peak acceleration: 981 m/S2 Duration of pulse: 6ms 3 times in each of 3(X,Y,Z)axes. The specimen must be fixed on test board. Three successive shock shall be applied in the perpendicular direction of each surface of the specimen. | Change from an initial value L : within±10% |
| 自然落下试验 Free fall test | | |
| 焊锡付着性 Solder ability | Terminals shall be immersed for 5 to 10 seconds in flux at room temperature. Dip | 90%以上的面积要被 覆盖。 New solder shall cover 90% minimum of the surface immersed. |
| 耐电压 Dielectric strength | 在电极与磁材之间加入直流电压100V 通电时间 1 分钟。 100V DC shall be applied for 60s between the terminal and the core. | 没有损害。 Without damage. |



| | 试验方法Test method 热风炉焊接Reflow soldering method 预热Preheat 150~180℃ 90±30s 峰值温度Peak temp 250(+ 5,-0)℃ (230℃min, | | |
|--|--|---|--|
| 焊锡耐热性 Resistance to soldering heat | 30±10s) 试验板的厚度0.8mm 上按上面条件通过两次热风炉。 The specimen shall be subjected to the reflow process under the above condition 2 times.Test board shall be 0.8mm thick. Base material shall be glass epoxy resin. | Change from an initial value L : within±10% | |
| | 测定Measurement 常温常湿中放置于1 小时以上测试。 The specimen shall be stored at standard atmospheric conditions for 1 h in prior to the measurement. | | |
| 绝缘抵抗 Insulation resistance | 在电极与磁材之间加入直流电压100V。 100V DC shall be applied between the terminal and the core. | 100mΩ以上 100mΩ or more. | |
| | 在温度-40±3℃中放置500±12 小时后,常温常湿中放置1 小时以上2 小时以内测试。 | | |
| 耐寒性 Low temperature | temperature of -40±3°C for 500 ±12h. Then | Change from an initial value L : within±10% | |
| | 在温度85±2℃中放置500±12 小时后·常温常湿中放置1 小时以上2 小时以内测试。 | | |
| 耐热性 Dry heat | Itaman aratura of OF 1 2°C for FOO 1 126 Than | Change from an initial value L : within±10% | |



| 耐湿性 Dump heat | shall be stabilized under standard atmospheric conditions for 1 h before measurement. Measurement shall be made within 1h. | Change from an initial value L : within±10% |
|---------------------------|--|---|
| 温度循环 Temperature cycle | Icontinuous cycles of temperature change of I | Change from an initial value L : within±10% |

标准状态Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions in making measurements and test as follows;

Ambient temperature : 5°C to 35°C, Relative humidity: 45% to 85%, Air pressure: 86kPa to 106kPa

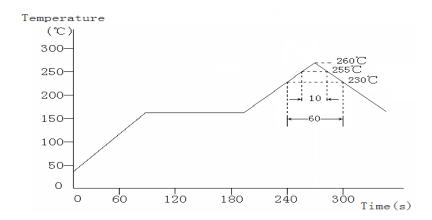
If more strict measurement is required, measurement shall be made within following limits; Ambient temperature: 20±2°C, Relative humidity: 65±5%, Air pressure: 86kPa to 106kPa

禁用物质Prohibited Subtances

我公司保证我司的产品和生产过程符合"RoHS 规则",所有产品中使用的材料均是化学物质生产规则中登记的材料。

We confirm that our products and our production process accord with "rule of RoHS". All materials used in this product are registered material under the law concerning the examination and Regulation of Manufacture of Chemical Substances.

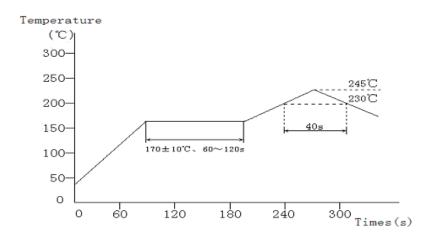
⊕ Reflow Soldering Heat Endurance



No mechanical and electrical defects are found after testing based on the above profile and keeping under the conditions of room temperature and humidity for 2 hours. Twice reflow test is acceptable with the test interval remaining 1 hour under the normal conditions.

The reflow test profile may vary with the testing instruments.

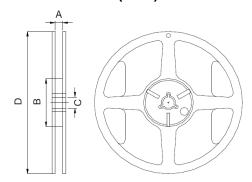
⊕ Recommended Reflow Conditions



The recommended reflow profile is based on the testing instruments used. Solder ability will depend on the testing equipments, reflow conditions, testing method, etc. So it is necessary to make a confirmation of them when the reflow conditions are set up.

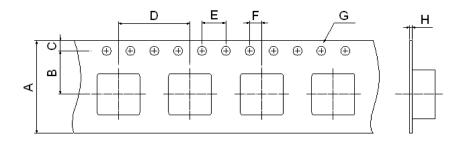
However halogen lamp shall be used, side heat will be beyond range of resistance heat, so we can't recommend it.

⊕Reel Dimension(m/m)



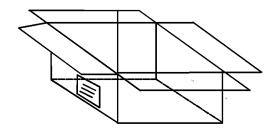
| Item | A(mm) | B(mm) | C(mm) | D(mm) |
|------------|-------|-------|-------|-------|
| AMP201610S | 8 | 60 | 13 | 178 |
| AMP252010S | 8 | 60 | 13 | 178 |
| AMP252012S | 8 | 60 | 13 | 178 |

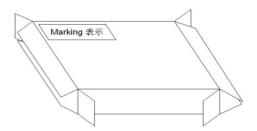
⊕2. Taping Dimension(m/m)



| Item | A(mm) | B(mm) | C(mm) | D(mm) | E(mm) | F(mm) | G(mm) | H(mm) |
|------------|-------|-------|-------|-------|-------|-------|-------|-------|
| AMP201610S | 8 | 3.5 | 1.75 | 8 | 4 | 2 | 1.5 | 0.25 |
| AMP252010S | 8 | 3.5 | 1.75 | 8 | 4 | 2 | 1.5 | 0.25 |
| AMP252012S | 8 | 3.5 | 1.75 | 8 | 4 | 2 | 1.5 | 0.25 |

⊕ Packaging Carton





| Item | Reel Packing Unit | Inner Box Packing Unit | Carton Packing Unit |
|------------|-------------------|------------------------|---------------------|
| AMP201610S | 3000 PCS / Reel | 15000 PCS / Box | 150000 PCS / Box |
| AMP252010S | 3000 PCS / Reel | 15000 PCS / Box | 150000 PCS / Box |
| AMP252012S | 3000 PCS / Reel | 15000 PCS / Box | 150000 PCS / Box |